

**3N50**

Preliminary

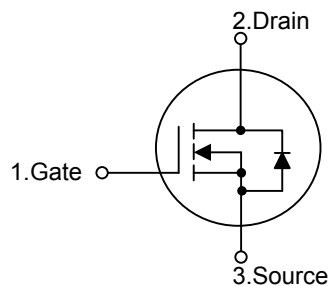
Power MOSFET**3 Amps, 500 Volts
N-CHANNEL POWER MOSFET****DESCRIPTION**

The UTC **3N50** is an N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology allows a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC **3N50** is generally applied in high efficiency switch mode power supplies, active power factor correction and electronic lamp ballasts based on half bridge topology.

FEATURES

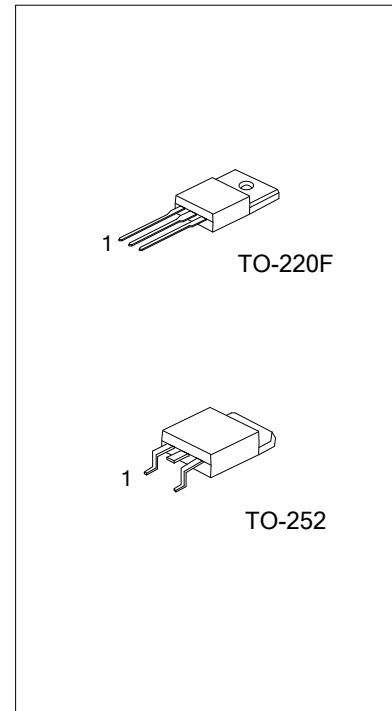
- * 3A, 500V, $R_{DS(ON)}=2.5\Omega$ @ $V_{GS}=10V$
- * High Switching Speed
- * 100% Avalanche Tested

SYMBOL**ORDERING INFORMATION**

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
3N50L-TF3-T	3N50G-TF3-T	TO-220F	G	D	S	Tube
3N50L-TN3-R	3N50G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

3N50L-TF3-T (1) Packing Type (2) Package Type (3) Lead Free		(1) T: Tube, R: Tape Reel (2) TF3: TO-220F, TN3: TO-252 (3) G: Halogen Free, L: Lead Free
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■ ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$, unless otherwise specified)

PARAMETER			SYMBOL	RATINGS	UNIT
Drain-Source Voltage			V _{DSS}	500	V
Gate-Source Voltage			V _{GSS}	±30	V
Drain Current	Continuous (T _C =25°C)		I _D	3 *	A
	Pulsed (Note 1)		I _{DM}	12 *	A
Avalanche Current (Note 1)			I _{AR}	3	A
Avalanche Energy	Single Pulsed (Note 2)		E _{AS}	200	mJ
	Repetitive (Note 3)		E _{AR}	6.2	mJ
Peak Diode Recovery dv/dt (Note 3)			dv/dt	4.5	V/ns
Power Dissipation	T _C =25°C	TO-220F	P _D	25	W
		TO-252		50	
	Derate above 25°C	TO-220F		0.2	W/°C
		TO-252		0.4	
Junction Temperature			T _J	+150	°C
Storage Temperature			T _{STG}	-55~+150	°C

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

* Drain current limited by maximum junction temperature

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220F	θ_{JA}	62.5	$^\circ\text{C/W}$
	TO-252		110	
Junction to Case	TO-220F	θ_{JC}	4.9	$^\circ\text{C/W}$
	TO-252		2.5	

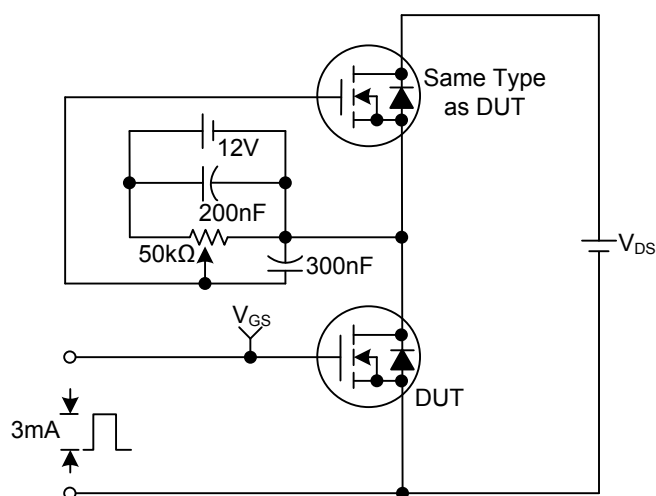
■ ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$, unless otherwise noted)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	I _D =250μA, V _{GS} =0V	500			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =500V, V _{GS} =0V			1	μA
Gate- Source Leakage Current	Forward	I _{GSS}	V _{GS} =+30V, V _{DS} =0V			+100	nA
	Reverse		V _{GS} =-30V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250μA	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =1.5A		2.1	2.5	Ω
DYNAMIC PARAMETERS							
Input Capacitance		C _{ISS}	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		280	365	pF
Output Capacitance		C _{OSS}			50	65	pF
Reverse Transfer Capacitance		C _{RSS}			8.5	11	pF
SWITCHING PARAMETERS							
Total Gate Charge		Q _G	V _{GS} =10V, V _{DS} =400V, I _D =3A (Note 4, 5)		10	13	nC
Gate to Source Charge		Q _{GS}			1.5		nC
Gate to Drain Charge		Q _{GD}			5.5		nC
Turn-ON Delay Time		t _{D(ON)}	V _{DD} =250V, I _D =3A, R _G =25Ω (Note 4, 5)		10	30	ns
Rise Time		t _R			25	60	ns
Turn-OFF Delay Time		t _{D(OFF)}			35	80	ns
Fall-Time		t _F			25	60	ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I _S				3	A
Maximum Body-Diode Pulsed Current		I _{SM}				12	A
Drain-Source Diode Forward Voltage		V _{SD}	I _S =3A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time		t _{RR}	I _S =3A, V _{GS} =0V, dI _F /dt=100A/μs		170		ns
Body Diode Reverse Recovery Charge		Q _{RR}	(Note 4)		0.7		μC

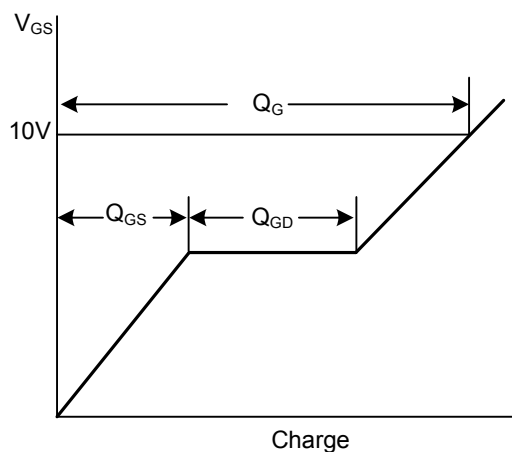
- Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. $L = 40\text{mH}$, $I_{AS} = 3\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$
3. $I_{SD} \leq 3\text{A}$, $dI/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$
4. Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$
5. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

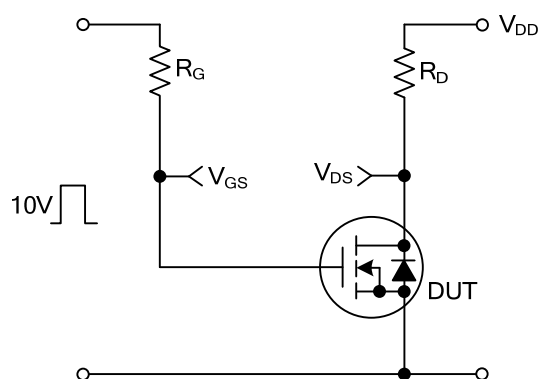
Gate Charge Test Circuit



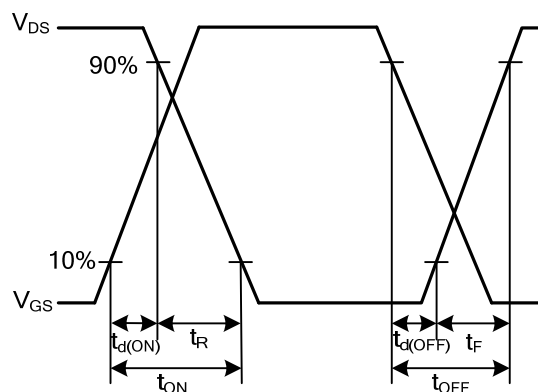
Gate Charge Waveforms



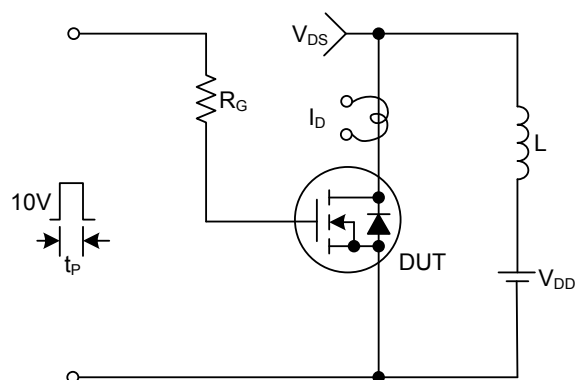
Resistive Switching Test Circuit



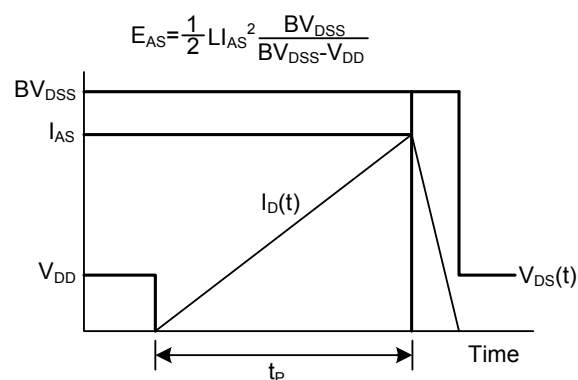
Resistive Switching Waveforms



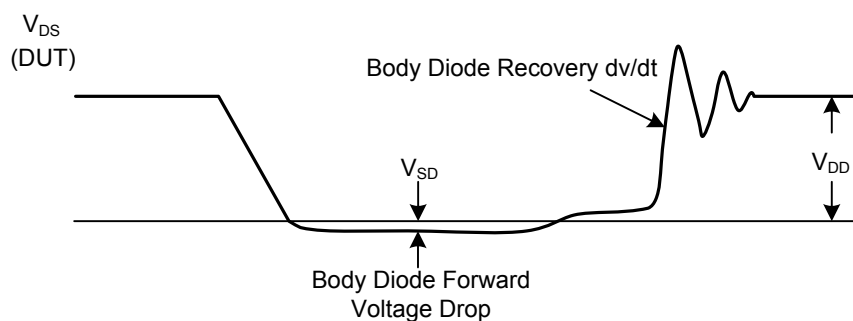
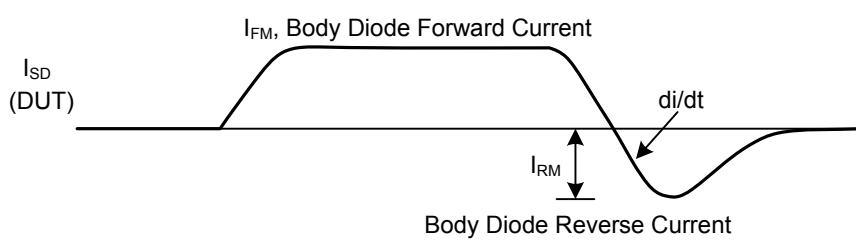
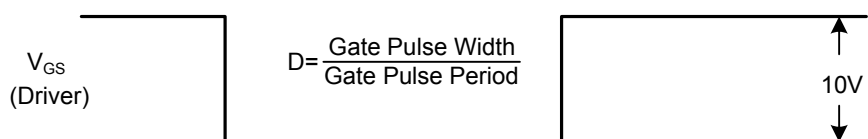
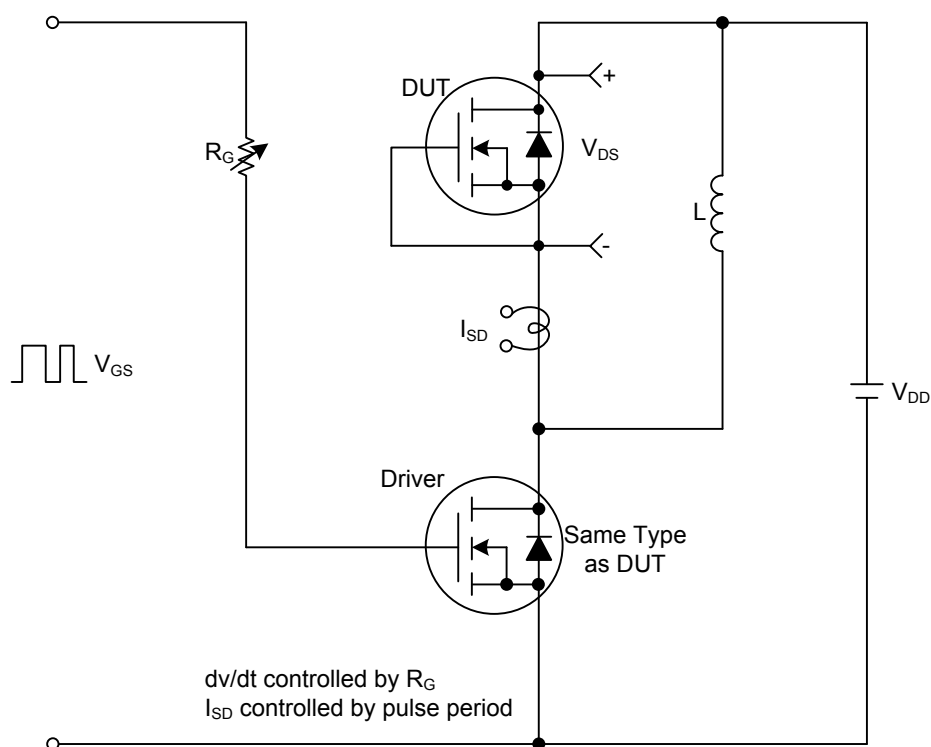
Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms



Peak Diode Recovery dv/dt Test Circuit & Waveforms



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